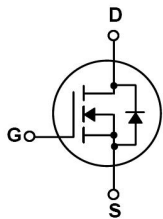
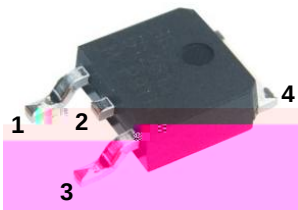


/ Descriptions**/ Features****/ Applications****/ Equivalent Circuit****/ Pinning****/ h_{FE} Classifications & Marking**

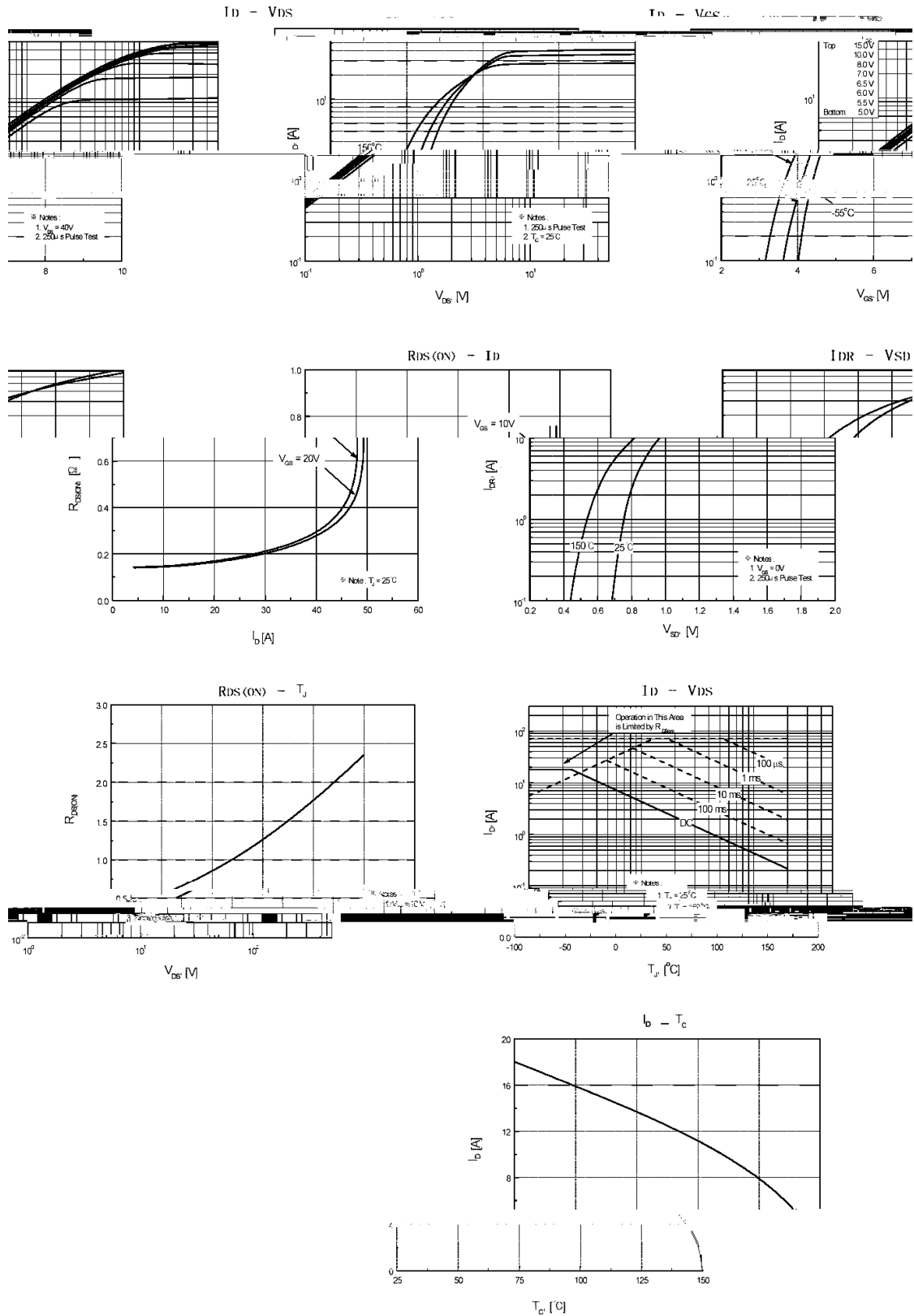
/ Absolute Maximum Ratings(Ta=25)

	θ		
	θ		

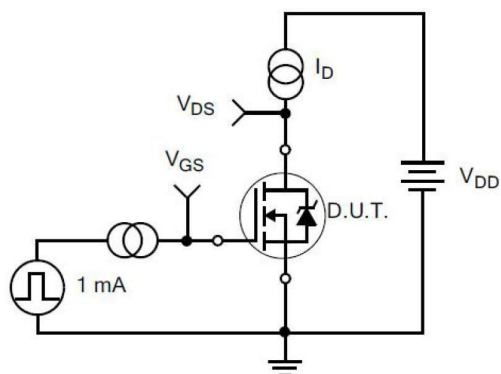
/ Electrical Characteristics(Ta=25)

		μ				
						μ
						μ
						μ
		μ				
						Ω
		Ω				

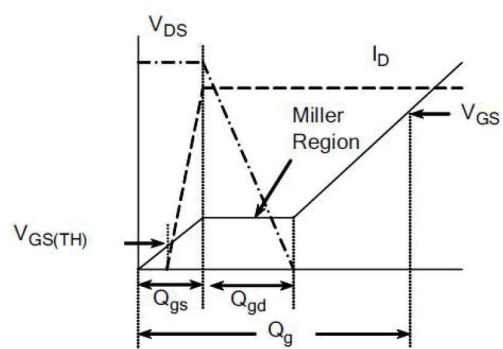
/ Electrical Characteristic Curve



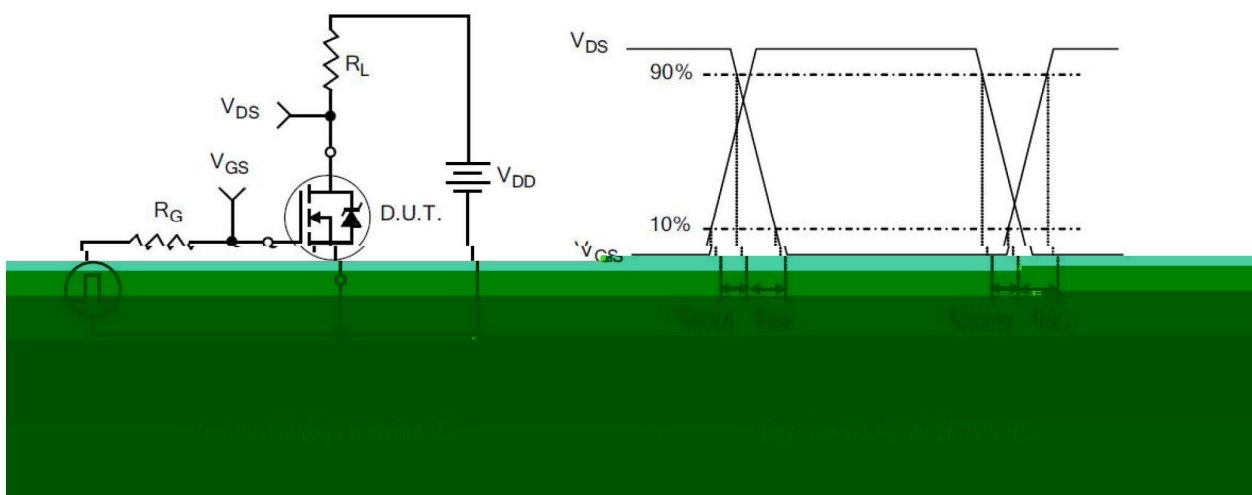
/ Test Circuit and Waveform Curve



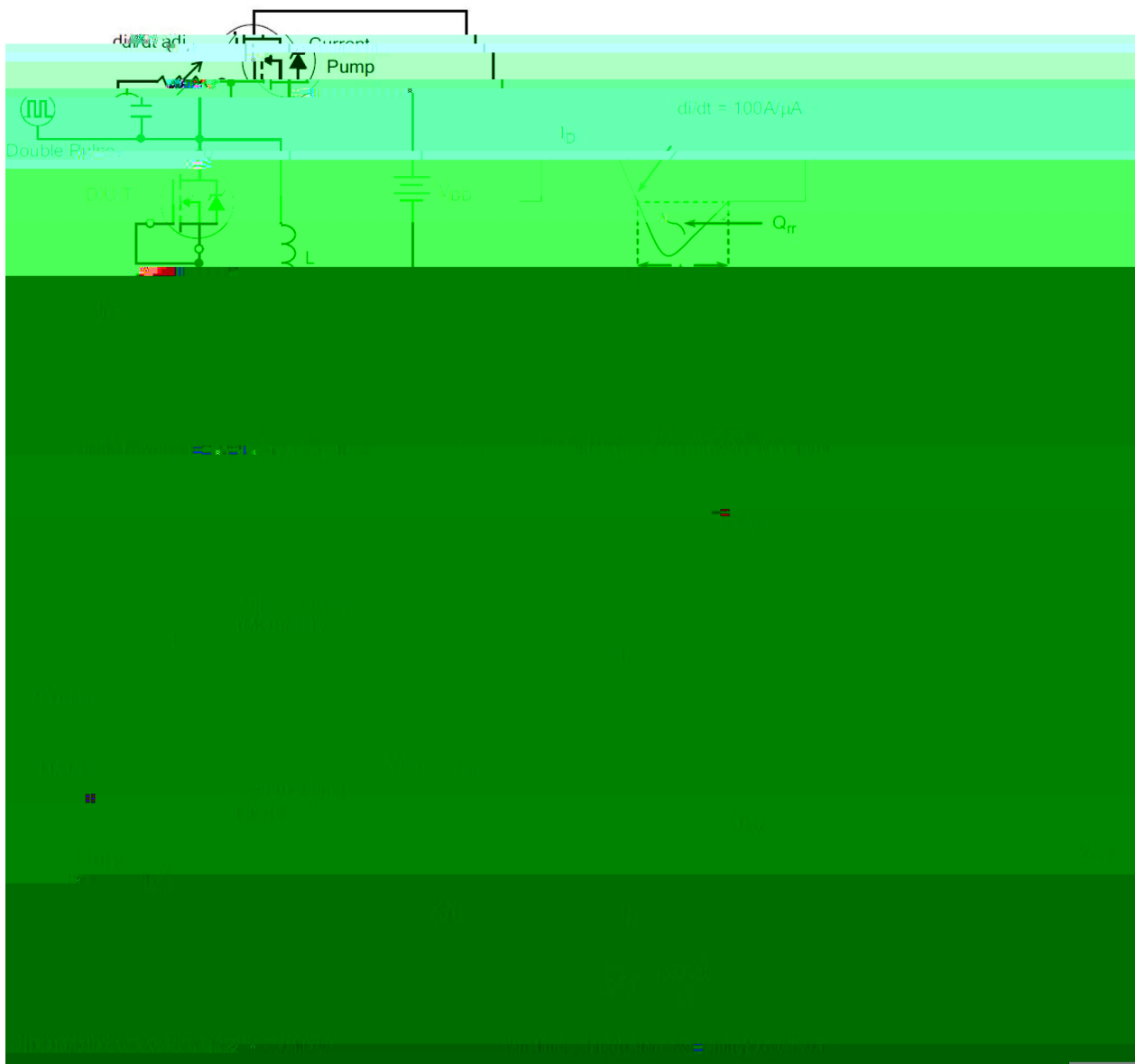
Gate Charge Test Circuit



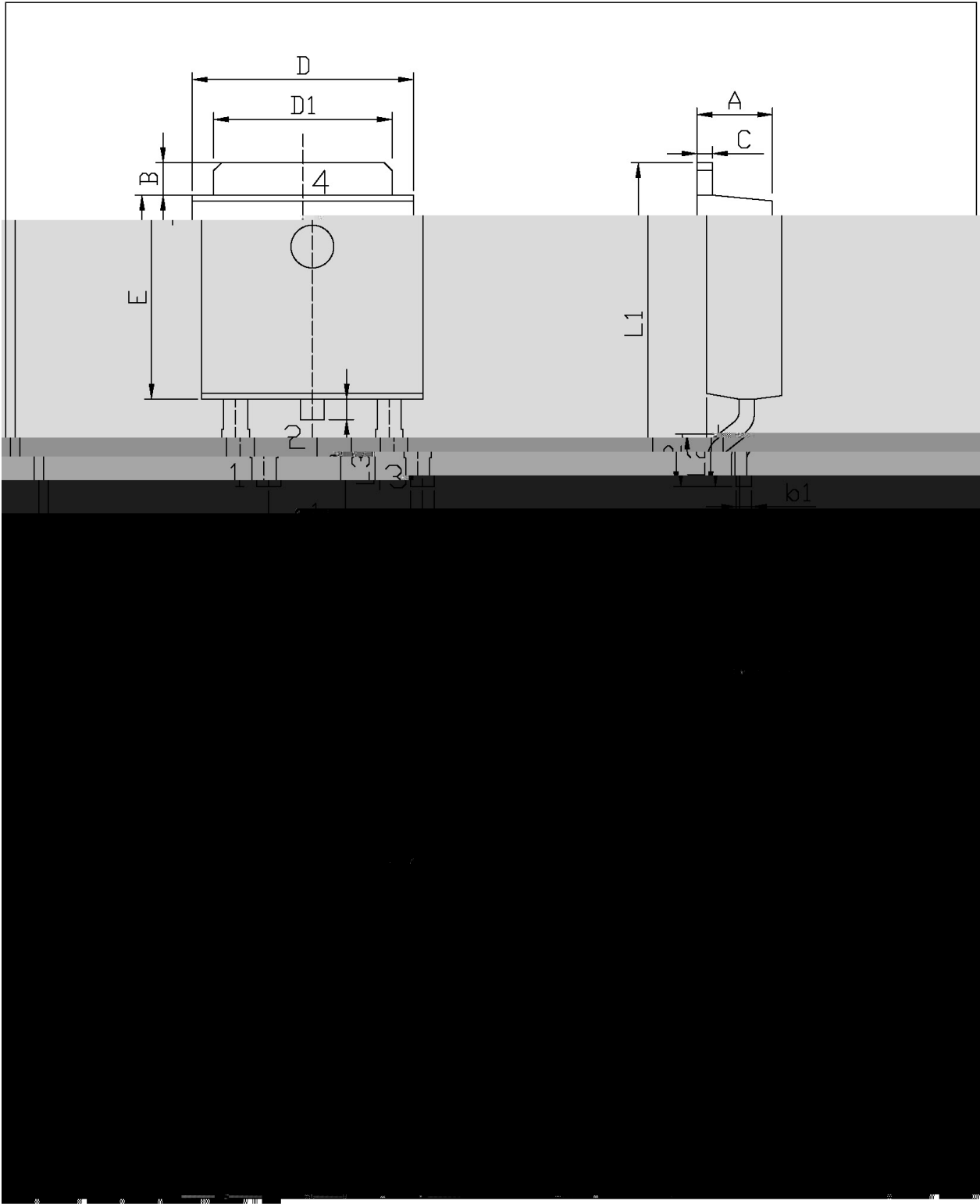
Gate Charge Waveform



/ Test Circuit and Waveform Curve

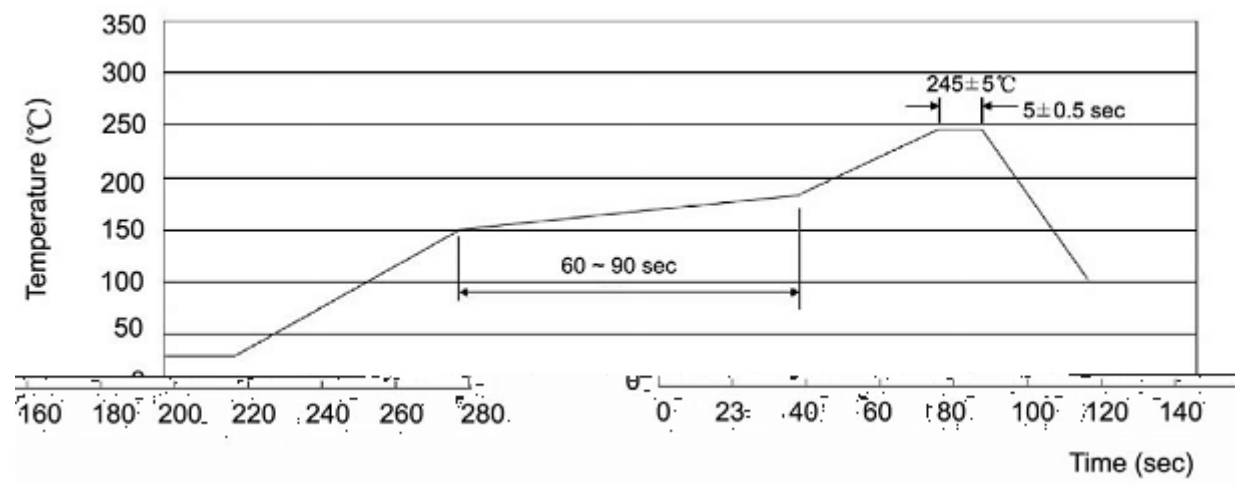


/ Package Dimensions



BRD640

() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-252	2,500	2	5,000	5	25,000	13 ×16	360×360×50	385×257×392

封装形式	包装数量					包装尺寸		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	575×290×180

/ Notices